

ATTORNEY DOCKET 12636.001

Inventors: Shu WANG; Andrew C.A. WAN;
 Harry YU; Kam W. LEONG
 Institute of Materials Research and Engineering
 National University of Singapore

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SUPPLEMENTAL DECLARATION FOR PATENT APPLICATION

As inventors named below or on any attached continuation page, we hereby declare that:

Our residence, post office address and citizenship are as stated next to our names.

We believe that we are the original, first and joint inventors of the subject matter which is claimed and for which a patent is sought on the invention entitled "A POLYMER AND NERVE GUIDE CONDUITS FORMED THEREOF", the specification of which (check one):

is attached hereto.

was filed on 4 December 2001 as United States application serial no. 10/000,297 and was amended on 4 March 2004.

was filed on _____ as PCT international application no. _____ and was amended under PCT Article 19 on _____.

We hereby state that we have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

We acknowledge the duty to disclose to the U.S. Patent and Trademark Office all information known to us to be material to the patentability of the subject matter claimed in this application, as "materiality" is defined in Title 37, Code of Federal Regulations § 1.56.

We hereby claim foreign priority benefits under Title 35, United States Code, § 119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate or § 365(a) of any PCT international application(s) designating at least one country other than the United States of America listed below and on any attached continuation page and have also identified below and on any attached continuation page any foreign application for patent or inventor's certificate or any PCT international application(s) designating at least one country other than the United States of America having a filing date before that of the application(s) on which priority is claimed.

Prior application(s):	foreign/PCT (number)	U.S.A. (country)	14 April 1998 (day/month/year filed)	<input checked="" type="checkbox"/> Yes	Priority Claimed No

573524.1

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 National University of Singapore

We hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) or § 365(c) of PCT international application(s) designating the United States of America listed below and on any attached continuation page and, insofar as the subject matter of each of the claims of this application is not disclosed in any such prior application in the manner provided by the first paragraph of Title 35, United States Code, § 112, we acknowledge the duty to disclose to the U.S. Patent and Trademark Office all information known to us to be material to patentability as defined in Title 37, Code of Federal Regulations § 1.56 which became available between the filing date of such prior application and the national or PCT international filing date of this application:

U.S. Patent No. 6,238,687 (application serial no.)	5 April 1999 (filing date)	Patented (status - pending, patented or abandoned)
U.S. Patent No. 5,912,225 (application serial no.)	14 April 1997 (filing date)	Patented (status - pending, patented or abandoned)
		(status - pending, patented or abandoned)

We hereby claim the benefit under Title 35, United States Code, § 119(e) of any United States provisional application(s) listed below:

(provisional application no.)	(filing date)
(provisional application no.)	(filing date)

Address all correspondence to: Vanessa B. Pierce

Parsons Behle & Latimer
 One Utah Center
 201 South Main Street, Suite 1800
 Salt Lake City, Utah 84145-0898
 (801) 532-1234

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We hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of first inventor: Shu Wang

Inventor's Signature _____ Date _____

Residence: Singapore

Citizenship: Sweden

Post Office Address: 103 Clementi Road

Kent Vale, Blk A, #05-07

Singapore 129789

Full name of second inventor: Andrew C.A. Wan

Inventor's Signature _____ Date _____

Residence: Baltimore, Maryland

Citizenship: Malaysia

Post Office Address: 720 Rutland Avenue

726 Ross Research Building

Biomedical Engineering Department

Johns Hopkins School of Medicine

Baltimore, MD 21205

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Inventors: Shu WANG; Andrew C.A. WAN;
Hanry YU; Kam W. LEONG
Institute of Materials Research and Engineering
National University of Singapore

Full name of third inventor: Hanry Yu

Inventor's Signature _____ Date _____

Residence: Irvine, California

Citizenship: China

Post Office Address: 9 Princeton

Irvine, CA 92720

Full name of fourth inventor: Kam W. Leong

Inventor's Signature _____ Date _____

Residence: Ellicott City, Maryland

Citizenship: U.S.A.

Post Office Address: 10242 Breconshire Road

Ellicott City, MD 21042